

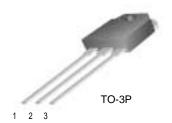
## FFA60U60DN

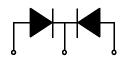
### **Features**

- High voltage and high reliability
- · High speed switching
- Low forward voltage

## **Applications**

- General purpose
- Switching mode power supply
- Free-wheeling diode for motor application
- · Power switching circuits





1. Anode 2. Cathode 3. Anode

## **ULTRA FAST RECOVERY POWER RECTIFIER**

## Absolute Maximum Ratings (per diode) T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	600	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 100°C	60	А
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	360	А
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

## **Thermal Characteristics**

Symbol		Parameter	Value	Units
	R <sub>e.IC</sub>	Maximum Thermal Resistance, Junction to Case	0.45	°C/W

## Electrical Characteristics (per diode) T<sub>C</sub>=25 °C unless otherwise noted

Parameter		Min.	Тур.	Max.	Units
Maximum Instantaneous Forward Voltage	T 25.0C			2.2	V
I <sub>F</sub> = 60A I <sub>F</sub> = 60A	$T_{\rm C} = 25^{\circ}{\rm C}$ $T_{\rm C} = 100^{\circ}{\rm C}$	-	-	2.2	
Maximum Instantaneous Reverse Current					μΑ
@ rated V <sub>R</sub>	$T_C = 25  ^{\circ}C$	-	-	25	
	T <sub>C</sub> = 100 °C	-	-	250	
Maximum Reverse Recovery Time		-	-	90	ns
Maximum Reverse Recovery Current		-	-	9	Α
Maximum Reverse Recovery Charge (I <sub>F</sub> =60A, di/dt = 200A/μs)		-	-	405	nC
Avalanche Energy		1.0	-	-	mJ
	$\begin{aligned} &\text{Maximum Instantaneous Forward Voltage} \\ &I_F = 60A \\ &I_F = 60A \end{aligned}$ $&I_F = 60A $ $&\text{Maximum Instantaneous Reverse Current} \\ &@ \text{ rated } V_R $ $&\text{Maximum Reverse Recovery Time} \\ &\text{Maximum Reverse Recovery Current} \\ &\text{Maximum Reverse Recovery Charge} \\ &(I_F = 60A, \text{di/dt} = 200A/\mu\text{s}) \end{aligned}$	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	$\begin{tabular}{ll} Maximum Instantaneous Forward Voltage & $I_F=60A$ & $T_C=25\ ^\circ C$ & $-$\\ $I_F=60A$ & $T_C=100\ ^\circ C$ & $-$\\ \hline Maximum Instantaneous Reverse Current & $T_C=25\ ^\circ C$ & $-$\\ \hline & $T_C=100\ ^$	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

<sup>\*</sup> Pulse Test: Pulse Width=300μs, Duty Cycle=2%

# **Typical Characteristics**

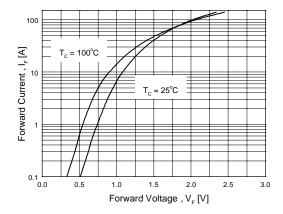


Figure 1. Typical Forward Voltage Drop vs. Forward Current

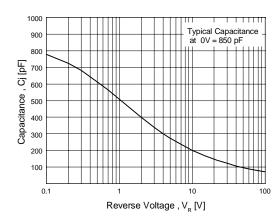


Figure 3. Typical Junction Capacitance

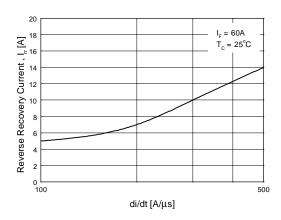


Figure 5. Typical Reverse Recovery Current vs. di/dt

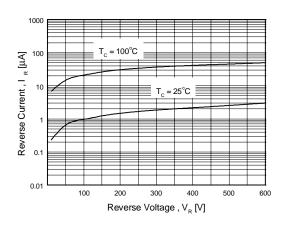


Figure 2. Typical Reverse Current vs. Reverse Voltage

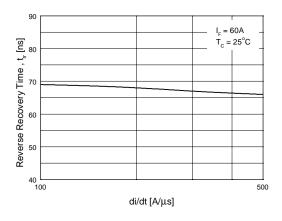


Figure 4. Typical Reverse Recovery Time vs. di/dt

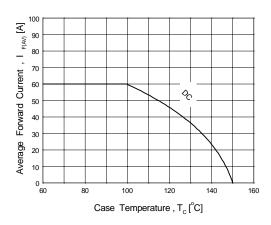
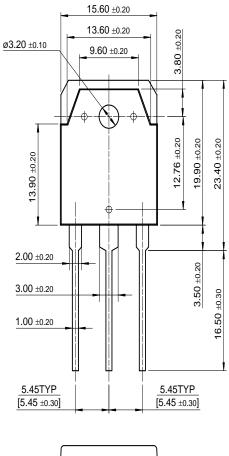


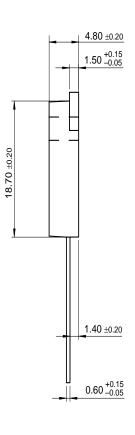
Figure 6. Forward Current Derating Curve

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# **Package Dimensions**

# TO-3P





Dimensions in Millimeters

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